

Description

The FMXA-1104S is a fast recovery diode of 400 V / $10\,$ A. The maximum t_{rr} of 25 ns is realized by optimizing a life-time control.

Features

•	V _{RM}	400	V
•	I _{F(AV)}	- 10	A
•	V_{F}	1.50	V
•	t _{rr}	25	ns

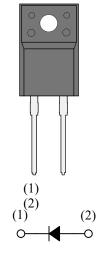
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

Applications

- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode
 (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

TO220F-2L



- (1) Cathode
- (2) Anode

Not to scale

FMXA-1104S

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V_{RSM}		400	V
Repetitive Peak Reverse Voltage	V_{RM}		400	V
Average Forward Current	I _{F(AV)}	See Figure 1 and Figure 2	10	A
Surge Forward Current	I _{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	100	A
I ² t Limiting Value	I ² t	$1 \text{ ms} \le t \le 10 \text{ ms}$	50	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop	V_{F}	$T_J = 25 ^{\circ}\text{C}, I_F = 10 \text{A}$			1.50	V
Forward Voltage Drop		$T_J = 100 ^{\circ}\text{C}, I_F = 10 \text{A}$		1.16	_	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$			100	μΑ
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_	_	30	mA
Reverse Recovery Time	t _{rr}	$I_F = I_{RP} = 500 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$	_		25	ns
Thermal Resistance ⁽¹⁾	R _{th(J-C)}		_	_	4.0	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.490		0.686	N·m
Package Weight		_	1.8	_	g

 $^{^{(1)}}$ $R_{th (J-C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Derating Curves

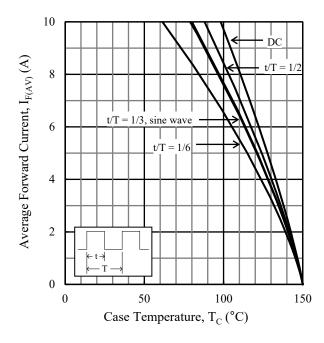


Figure 1. $I_{F(AV)}$ vs. T_C $(T_J = 150 \, ^{\circ}\text{C}, V_R = 0 \, \text{V})$

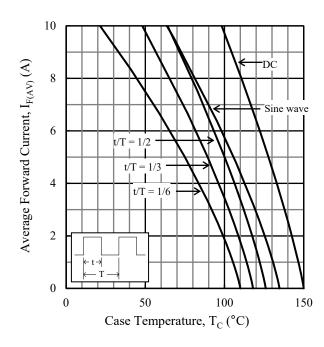


Figure 2. $I_{F(AV)}$ vs. T_C ($T_J = 150 \, ^{\circ}\text{C}$, $V_R = 400 \, \text{V}$)

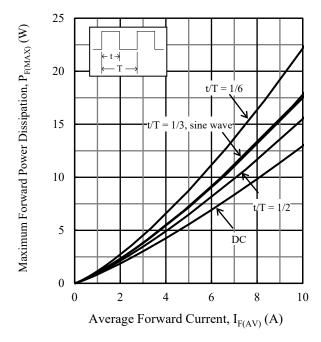


Figure 3. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

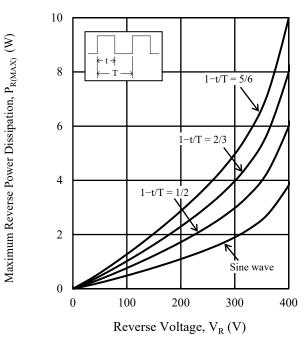


Figure 4. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

Characteristic Curves

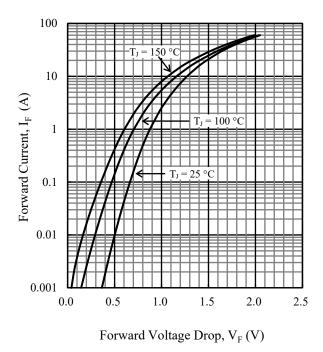


Figure 5. Typical Characteristics: V_F vs. I_F

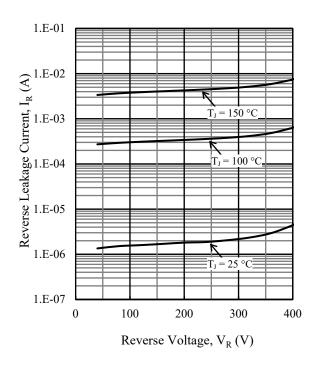


Figure 6. Typical Characteristics: V_R vs. I_R

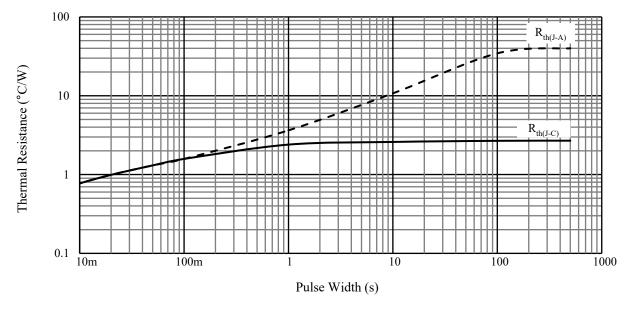
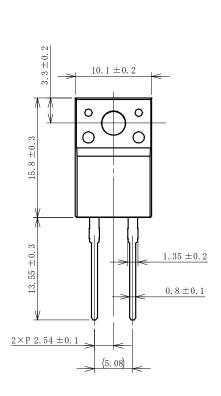
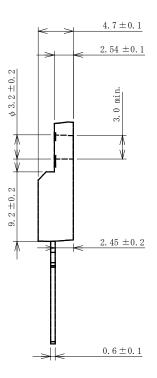


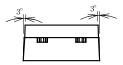
Figure 7. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• TO220F-2L







NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: 270 °C / 7 s, 1 time

Soldering Iron: 350 °C / 3.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

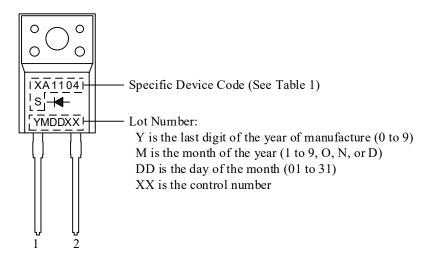


Table 1. Specific Device Code

Specific Device Code	Part Number
XA1104S	FMXA-1104S

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